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May 2001

FDS4501H Complementary PowerTrench[®] Half-Bridge MOSFET

General Description

This complementary MOSFET half-bridge device is produced using Fairchild's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

Applications

- DC/DC converter
- Power management
- · Load switch
- Battery protection

Features

Q1: N-Channel

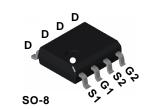
9.3A, 30V

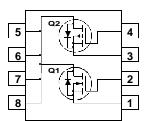
- $$\begin{split} R_{DS(on)} &= 18 \text{ m}\Omega \ @ \text{ V}_{GS} = 10 \text{V} \\ R_{DS(on)} &= 23 \text{ m}\Omega \ @ \text{ V}_{GS} = 4.5 \text{V} \end{split}$$
- Q2: P-Channel

–5.6A, –20V

 $R_{DS(on)} = 46 \text{ m}\Omega @ V_{GS} = -4.5V$

 $R_{DS(on)} = 63 \text{ m}\Omega @ V_{GS} = -2.5V$





Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter			Q1	Q2	Units
V _{DSS}	Drain-Source Voltage			30	-20	V
V _{GSS}	Gate-Source Voltage			±20	±8	V
b	Drain Current	- Continuous	(Note 1a)	9.3	-5.6	A
		- Pulsed		20	-20	
PD	Power Dissipation for Single Ope		(Note 1a)	2	.5	W
			(Note 1b)	1	.2	
			(Note 1c)		1	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			–55 to	°C	
Therma	I Characte	eristics				
R _{0JA}	Thermal Resistance, Junction-to-Ambient (Note 1a)		nt (Note 1a)	50		°C/W
R _{0JC}	Thermal Resistance, Junction-to-Case (Note 1)			2	°C/W	
Packag	e Marking	and Ordering In	formation			
Device Marking			Reel Size	Tape wi	dth	Quantity
FDS4501H		FDS4501H	13"	12mm	า	2500 units

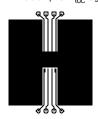
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Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Cha	racteristics						
BV _{DSS}	Drain-Source Breakdown	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	Q1	30			V
	Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	Q2	-20			
ΔBV_{DSS}	Breakdown Voltage	$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$	Q1		24		mV/°C
ΔT_{J}	Temperature Coefficient	$I_D = -250 \ \mu A$, Referenced to $25^{\circ}C$	Q2		-13		
DSS	Zero Gate Voltage Drain	$V_{DS} = 24 V, V_{GS} = 0 V$	Q1			1	μΑ
	Current	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$	Q2			-1	
GSS	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	Q1			<u>+</u> 100	nA
		$V_{GS} = \underline{+}8 \text{ V}, V_{DS} = 0 \text{ V}$	Q2			<u>+</u> 100	
On Char	acteristics (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	Q1	1	1.6	3	V
		$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	Q2	-0.4	-0.7	-1.5	
$\Delta V_{GS(th)}$	Gate Threshold Voltage	$l_{\rm D}$ = 250 µA, Referenced to 25°C	Q1		-4		mV/°C
ΔT_{J}	Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C	Q2		3		
R _{DS(on)}	Static Drain-Source	$V_{GS} = 10 \text{ V}, I_D = 9.3 \text{ A}$	Q1		14	18	mΩ
	On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 9.3 \text{ A}, T_J = 125^{\circ}\text{C}$			21	29	
		$V_{GS} = 4.5 \text{ V}, I_D = 7.6 \text{ A}$			17	23	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -5.6 \text{ A}$	Q2		36	46	
		$V_{GS} = -4.5 \text{ V}, I_D = -5.6 \text{ A}, T_J = 125^{\circ}\text{C}$			49	80	
		$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -5.0 \text{ A}$			47	63	-
D(on)	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	Q1	20			А
		$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	Q2	-20			0
g fs	Forward Transconductance	$V_{DS} = 5 V, I_D = 9.3 A$	Q1 Q2		28 16		S
		$V_{DS} = 5 V, I_D = -5.6 A$	QZ		10		
Dynamie	c Characteristics						
Ciss	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$	Q1		1958		pF
		f = 1.0 MHz	Q2		1312		-
Coss	Output Capacitance		Q1		424		pF
-			Q2		240		
Crss	Reverse Transfer Capacitance		Q1		182		pF
			Q2		106		

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Мах	Units
Switchir	ng Characteristics	lote 2)					
t _{d(on)}	Turn-On Delay Time	Q1 V _{DD} = 15 V, I _D = 1 A,	Q1 Q2		15 15	27 27	ns
tr	Turn-On Rise Time	$V_{GS} = 10V, R_{GEN} = 6 \Omega$ Q1	Q1 Q2		5 15	10 27	ns
t _{d(off)}	Turn-Off Delay Time	$V_{DD} = -10 \text{ V}, \text{ I}_D = -1 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	Q1 Q2		38 40	61 64	ns
t _f	Turn-Off Fall Time		Q1 Q2		10 25	20 40	ns
Qg	Total Gate Charge	Q1 V _{DS} = 15 V, I _D = 9.3 A, V _{GS} = 4.5 V	Q1 Q2		17 13	27 21	nC
Q _{gs}	Gate-Source Charge	Q2	Q1 Q2		4 2.5		nC
Q _{gd}	Gate-Drain Charge	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = -2.4 \text{ A}, \text{V}_{GS} = -4.5 \text{ V}$	Q1 Q2		5 2.0		nC
Drain-So	ource Diode Characte	eristics and Maximum Ratings					
ls	Maximum Continuous Drain-Source Diode Forward Current					2.1 -2.1	A
V _{SD}	Drain-Source Diode Forward $V_{GS} = 0 V$, $I_S = 2.1 A$ (Note 2) Voltage $V_{GS} = 0 V$, $I_S = -2.1 A$ (Note 2)		Q1 Q2			1.2 -1.2	V

Notes:

1. R_{8JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $\rm R_{BJC}$ is guaranteed by design while $\rm R_{BCA}$ is determined by the user's board design.



a) 50°C/W when mounted on a 1 in² pad of 2 oz copper



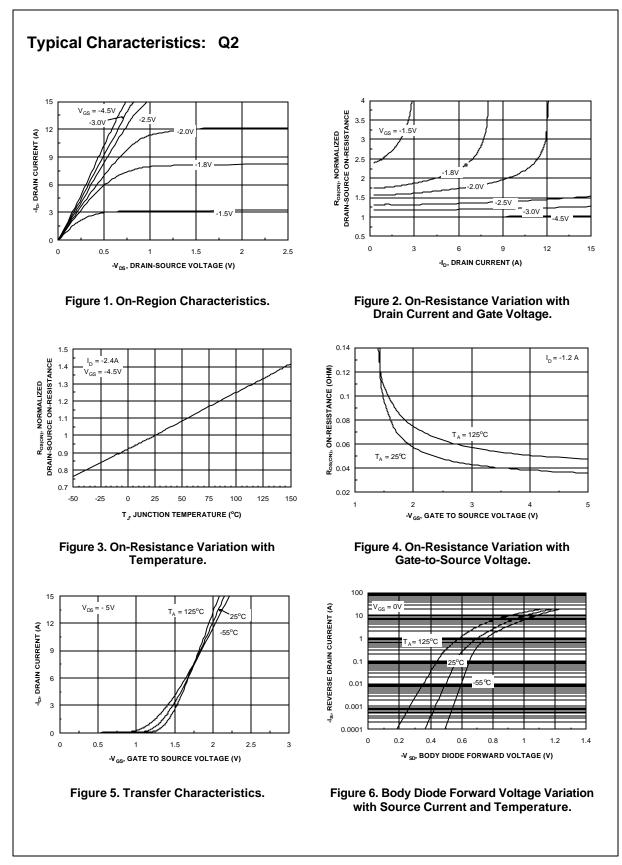
b) 105°C/W when mounted on a 0.04 in² pad of 2 oz copper

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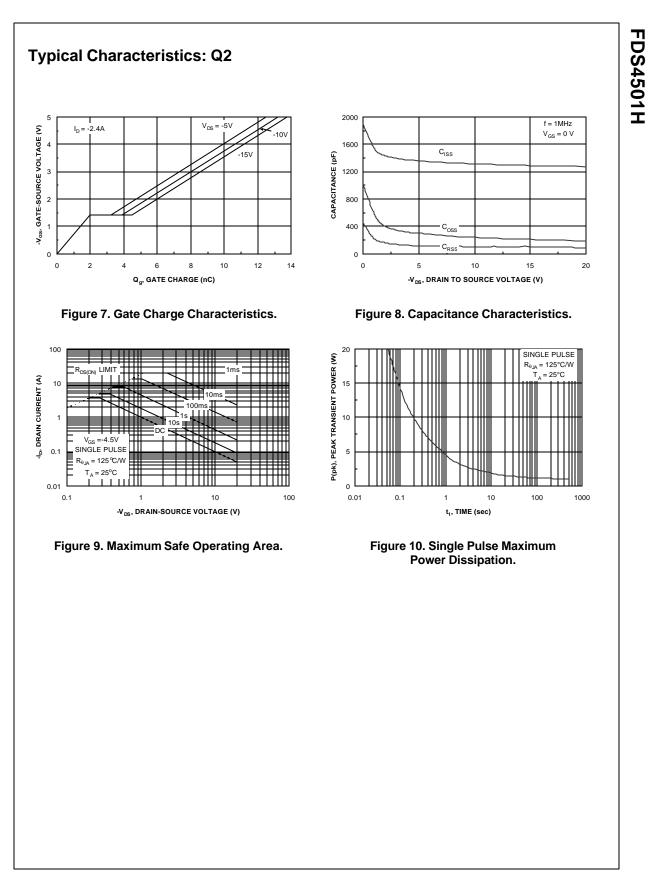
c) 125°C/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

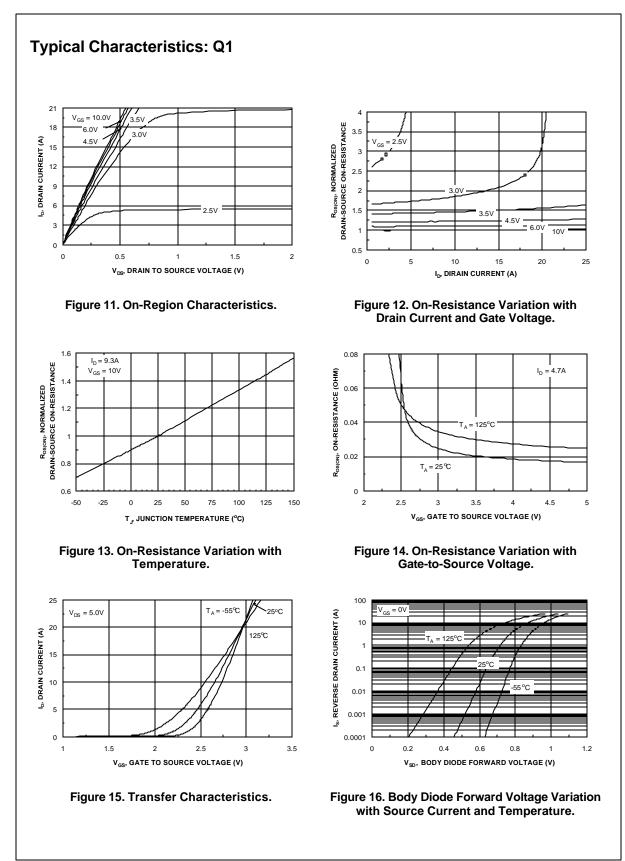
2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

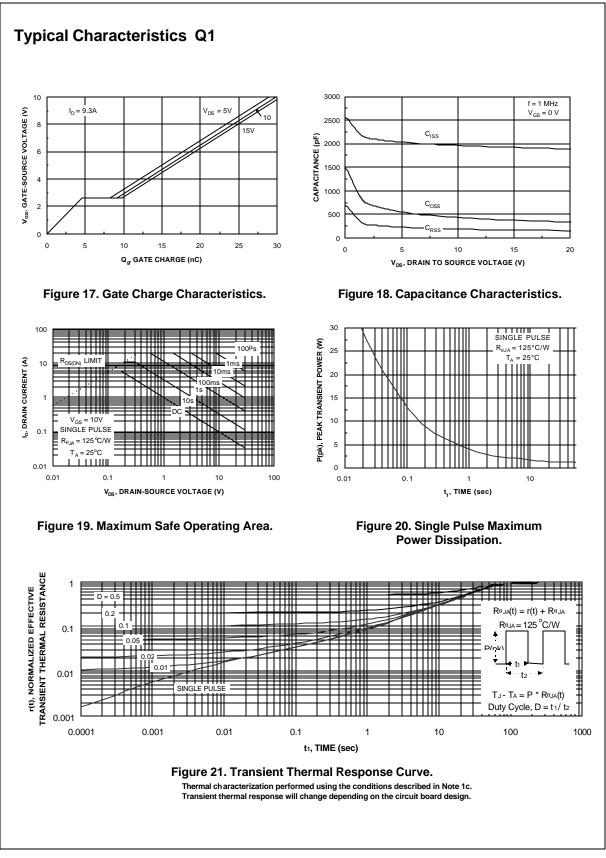


FDS4501H Rev C(W)



FDS4501H Rev C(W)





FDS4501H Rev C(W)

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